

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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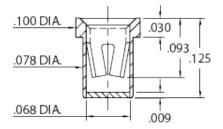




DATA SHEET

Product Number: 9873-0-67-80-02-27-10-0

With Organic Fibre Plug® Solder Barrier



Description:

9873 - Receptacle With OFP Solder Accepts .040-.050 diameter leads.

Packaged on Tape & Reel 4,500 per 13" reel

9873-0-XX-XX-02-XX-10-0

Solder mount in Ø.083±.003 PTH. #02 Contact for Ø.040-.050 pins. Also available on 12mm wide carrier tape: 4,500 parts per 13" reel.

Mill-Max Part Number	Shell Plating	Contact Plating	RoHS Compliant

9873-0-67-80-02-27-10-0

 $200 - 300 \mu$ " Tin (matte finish) over Nickel

30 µ" Gold over Nickel



CONTACT:

Contact Used: #02, Standard 6 Finger Contact

Current Rating = 8 Amps

BERYLLIUM COPPER ALLOY 172 (UNS C17200) per **ASTM B 194**

Properties of BERYLLIUM COPPER:

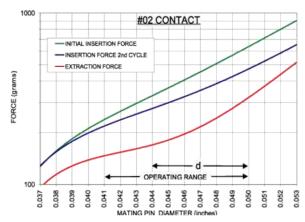
• Chemical composition: Cu 98.1%, Be 1.9%

• Temper as stamped: TD01

Properties after heat treatment (TH01):

- Hardness: 36-43 Rockwell C
- Mechanical Life: 100 Cycles Min.
- Density: .298 lbs/in3
- Electrical Conductivity: 22% IACS*
- Resistance: 10 miliohms Max
- Operating Temperature: -55°C/+125°C
- Melting point: 980°C/865°C (liquidus/solidus)
- Stress Relaxation†: 96% of stress remains after 1,000 hours @ 100 °C; 70% of stress remains after

1,000 hours @ 200 °C



The insertion/extraction/normal force characteristics above were derived using a 30 microinch gold plated contact and polished steel gauge pins having a bullet-shaped tip.

The curves represent typical average values. The charts only guide you in selecting a clip that is close to your specification. Your results may vary, so for your specification, we encourage you to obtain complimentary samples for your evaluation.

†Since BeCu loses its spring properties over time at high temperatures; it is rated for continuous use up to 150°C. For applications up to 300°C, Mill-Max offers many contacts in Beryllium Nickel. Contact Tech Support for more info.

^{*}International Annealed Copper Standard, i.e. as a % of pure copper.

SHELL MATERIAL:

BRASS ALLOY (UNS C36000) per ASTM B 16

Properties of BRASS ALLOY:

• Chemical composition: Cu 61.5%, Zn 35.4%, Pb 3.1%†
• Hardness as machined: 80-90 Rockwell B

• Density: .307 lbs/in3

Electrical conductivity: 26% IACS*
Melting point: 900°C/885°C (liquidus/solidus)

†(3 to 4% lead is used to permit "free machining" and is permitted by EC Directive 2002/95Annex 6; so all pin materials are RoHS compliant)

*International Annealed Copper Standard, i.e. as a % of pure copper.